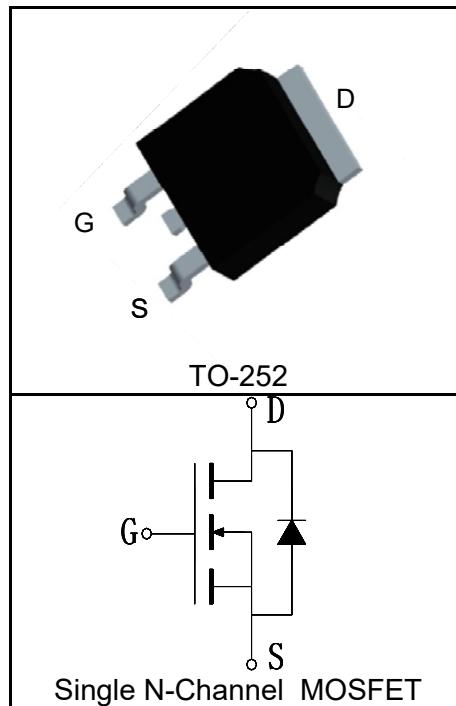


## Features

- 40V/90A,
- $R_{DS\ (ON)} = 4.5\text{m}\Omega$ (Typ.)@ $V_{GS}=10\text{V}$
- $R_{DS\ (ON)} = 6.5\text{m}\Omega$ (Typ.)@ $V_{GS}=4.5\text{V}$
- Low  $R_{DS\ (ON)}$
- Super High Dense Cell Design
- Reliable and Rugged

## Pin Description



## Applications

- Power Switching Application
- Load Switching



Halogen-Free

## Absolute Maximum Ratings

| Symbol   | Parameter                                       | Rating                  | Unit                      |
|--|---|-------------------------|---------------------------|
| <b>Common Ratings</b> ( $T_C=25^\circ\text{C}$ Unless Otherwise Noted) |   |                         |                           |
| $V_{DSS}$  | Drain-Source Voltage                            | 40                      | V                         |
| $V_{GSS}$  | Gate-Source Voltage                             | $\pm 20$                |                           |
| $T_J$  | Maximum Junction Temperature                    | 175                     | $^\circ\text{C}$          |
| $T_{STG}$  | Storage Temperature Range                       | -55 to 175              | $^\circ\text{C}$          |
| $I_S$  | Diode Continuous Forward Current                | $T_C=25^\circ\text{C}$  | A                         |
| <b>Mounted on Large Heat Sink</b>                                      |   |                         |                           |
| $I_{DP}^{(1)}$   | 300 $\mu\text{s}$ Pulse Drain Current Tested    | $T_C=25^\circ\text{C}$  | 360                       |
| $I_D^{(2)}$  | Continuous Drain Current( $V_{GS}=10\text{V}$ ) | $T_C=25^\circ\text{C}$  | 90                        |
|  |   | $T_C=100^\circ\text{C}$ | 63                        |
| $P_D$  | Maximum Power Dissipation                       | $T_C=25^\circ\text{C}$  | 75                        |
|  |   | $T_C=100^\circ\text{C}$ | 37                        |
| $R_{\theta JC}$  | Thermal Resistance-Junction to Case             | 2                       | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}^{(3)}$  | Thermal Resistance-Junction to Ambient          | 100                     | $^\circ\text{C}/\text{W}$ |
| <b>Drain-Source Avalanche Ratings</b>                                  |   |                         |                           |
| $E_{AS}^{(4)}$   | Avalanche Energy, Single Pulsed                 | 100                     | mJ                        |

**Electrical Characteristics (T<sub>C</sub>=25°C Unless Otherwise Noted)**

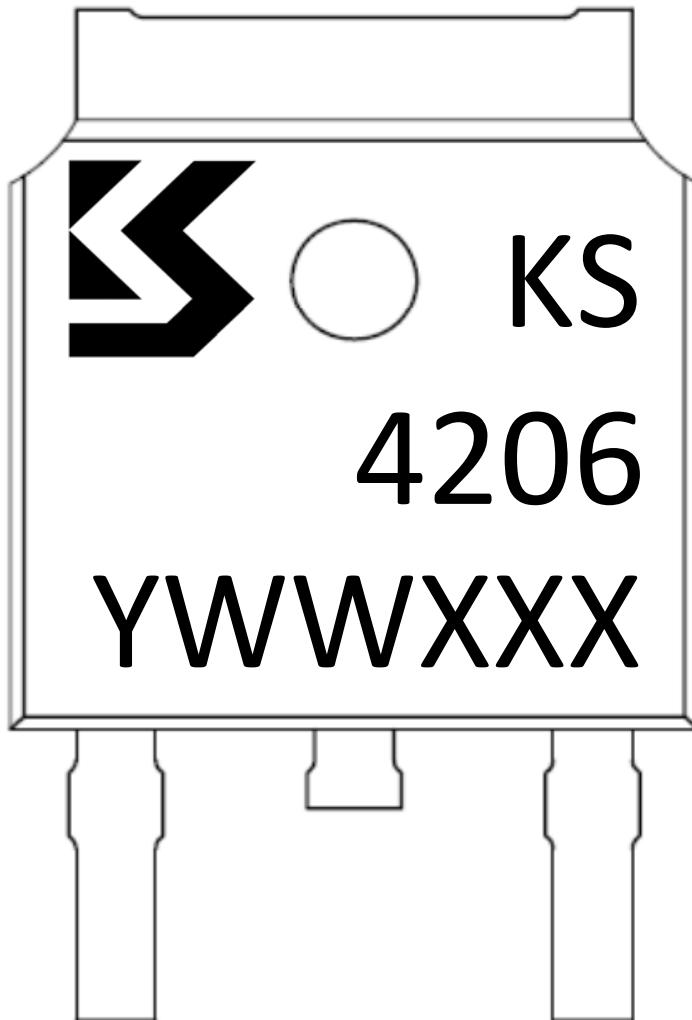
| Symbol   | Parameter                        | Test Condition   | KS4206DA |      |      | Unit |
|--|----------------------------------|--|----------|------|------|------|
|  |                                  |  | Min.     | Typ. | Max. |      |
| <b>Static Characteristics</b>                  |                                  |  |          |      |      |      |
| BV <sub>DSS</sub>                              | Drain-Source Breakdown Voltage   | V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA  | 40       |      |      | V    |
| I <sub>DSS</sub>                               | Zero Gate Voltage Drain Current  | V <sub>DS</sub> =40V, V <sub>GS</sub> =0V  |          |      | 1    | μA   |
|  |                                  | T <sub>J</sub> =125°C  |          |      | 30   |      |
| V <sub>GS(th)</sub>                            | Gate Threshold Voltage           | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250μA                                | 1        | 1.6  | 2.5  | V    |
| I <sub>GSS</sub>                               | Gate Leakage Current             | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V   |          |      | ±100 | nA   |
| R <sub>DS(ON)</sub> <sup>⑤</sup>               | Drain-Source On-state Resistance | V <sub>GS</sub> =10V, I <sub>DS</sub> =20A   |          | 4.5  | 6    | mΩ   |
|  |                                  | V <sub>GS</sub> =4.5V, I <sub>DS</sub> =16A  |          | 6.5  | 8    | mΩ   |
| <b>Diode Characteristics</b>                   |                                  |  |          |      |      |      |
| V <sub>SD</sub> <sup>⑤</sup>                   | Diode Forward Voltage            | I <sub>SD</sub> =20A, V <sub>GS</sub> =0V  |          | 0.8  | 1.2  | V    |
| t <sub>rr</sub>                                | Reverse Recovery Time            | I <sub>SD</sub> =20A, dI <sub>SD</sub> /dt=100A/μs                                       |          | 13   |      | ns   |
| Q <sub>rr</sub>                                | Reverse Recovery Charge          |  |          | 21   |      | nC   |
| <b>Dynamic Characteristics<sup>⑥</sup></b>     |                                  |  |          |      |      |      |
| R <sub>G</sub>                                 | Gate Resistance                  | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz   |          | 0.8  |      | Ω    |
| C <sub>iss</sub>                               | Input Capacitance                | V <sub>GS</sub> =0V,<br>V <sub>DS</sub> =20V,<br>Frequency=1.0MHz                        |          | 3915 |      | pF   |
| C <sub>oss</sub>                               | Output Capacitance               |  |          | 300  |      |      |
| C <sub>rss</sub>                               | Reverse Transfer Capacitance     |  |          | 255  |      |      |
| t <sub>d(ON)</sub>                             | Turn-on Delay Time               | V <sub>DD</sub> =20V, I <sub>DS</sub> =20A,<br>V <sub>GEN</sub> =10V, R <sub>G</sub> =3Ω |          | 11   |      | ns   |
| t <sub>r</sub>                                 | Turn-on Rise Time                |  |          | 8    |      |      |
| t <sub>d(OFF)</sub>                            | Turn-off Delay Time              |  |          | 54   |      |      |
| t <sub>f</sub>                                 | Turn-off Fall Time               |  |          | 14   |      |      |
| <b>Gate Charge Characteristics<sup>⑥</sup></b> |                                  |  |          |      |      |      |
| Q <sub>g</sub>                                 | Total Gate Charge                | V <sub>DS</sub> =20V, V <sub>GS</sub> =10V,<br>I <sub>DS</sub> =20A                      |          | 63   |      | nC   |
| Q <sub>gs</sub>                                | Gate-Source Charge               |  |          | 13   |      |      |
| Q <sub>gd</sub>                                | Gate-Drain Charge                |  |          | 12   |      |      |

Notes:

- ①Pulse width limited by safe operating area.
- ②Calculated continuous current based on maximum allowable junction temperature. The package limitation current is 60A.
- ③When mounted on 1 inch square copper board, t≤10sec. The value in any given application depends on the user's specific board design.
- ④Limited by T<sub>Jmax</sub>, I<sub>AS</sub> =20A, L=0.5mH, V<sub>DD</sub> = 30V, R<sub>G</sub> = 25Ω , Starting TJ = 25°C.
- ⑤Pulse test; Pulse width≤300μs, duty cycle≤2%.
- ⑥Guaranteed by design, not subject to production testing.

**Ordering and Marking Information**

| Device   | Package | Packaging | Quantity | Reel Size | Tape width |
|----------|---------|-----------|----------|-----------|------------|
| KS4206DA | TO-252  | Tape&Reel | 2500     | 13"       | 16mm       |

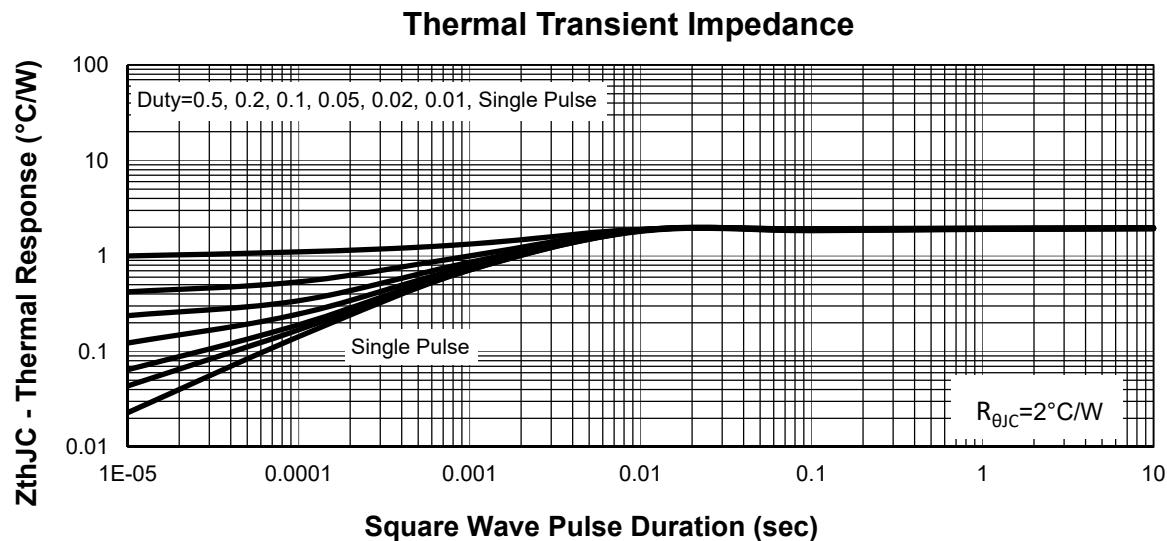
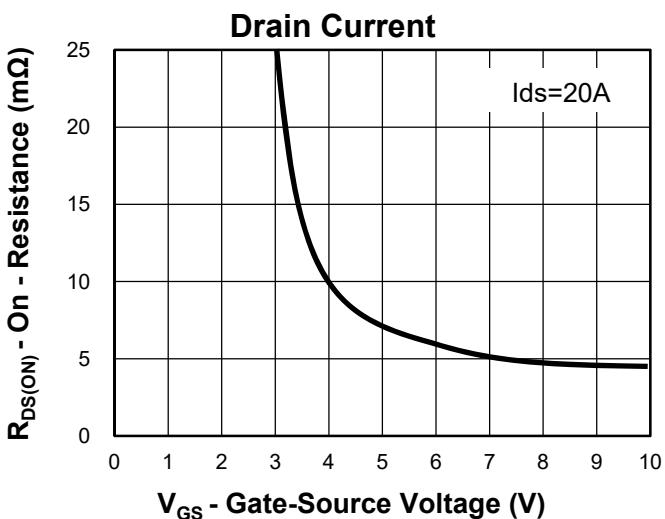
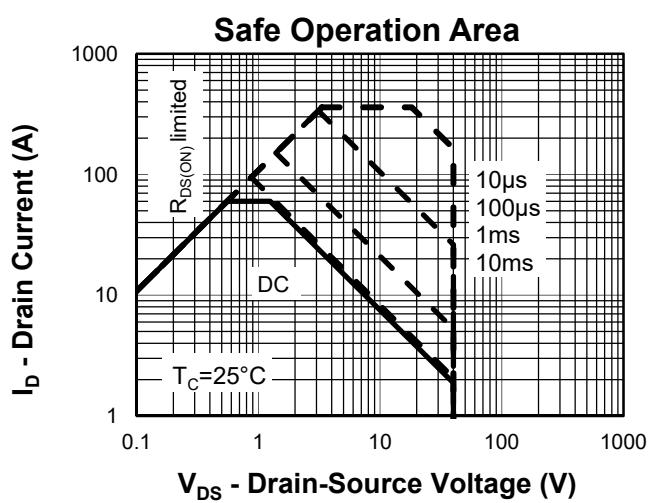
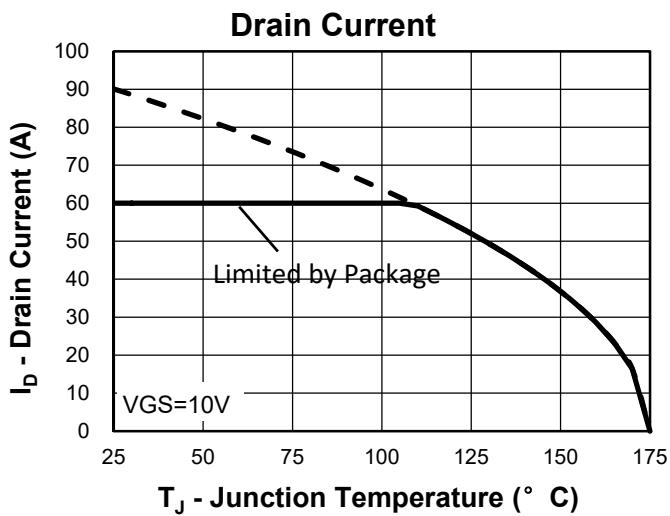
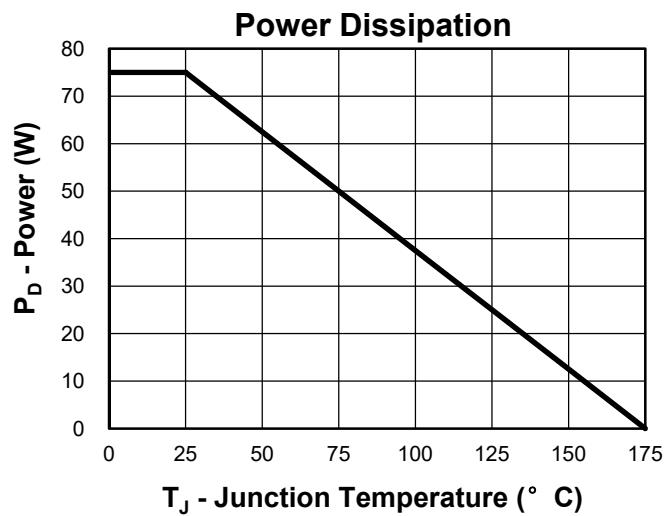


Y =Year,2017-A,2018-B,etc.

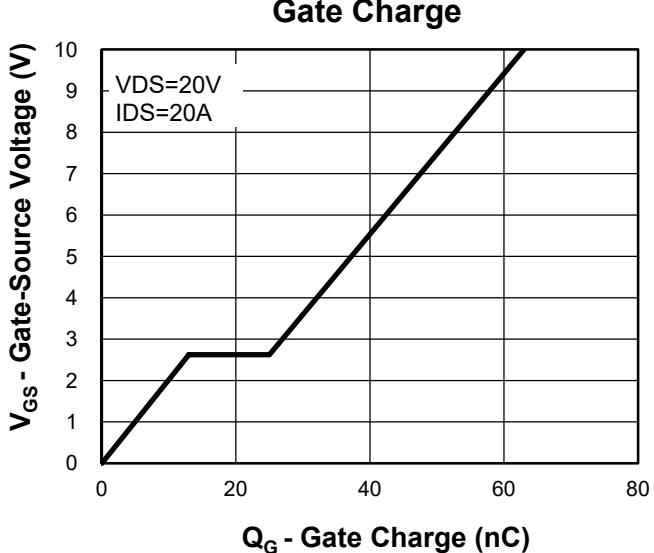
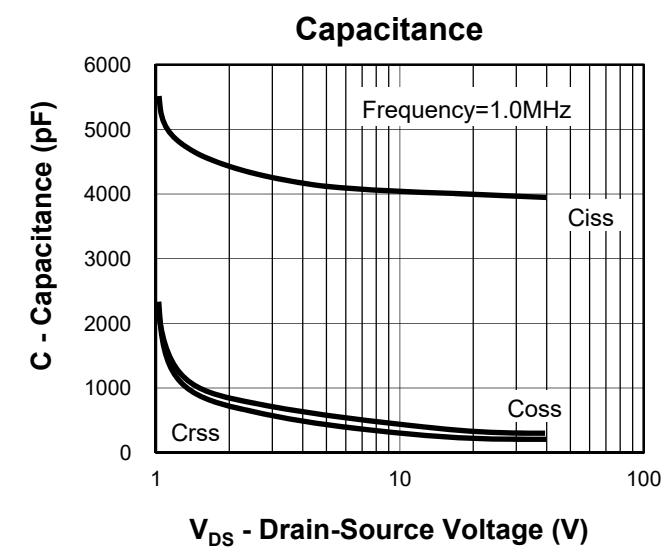
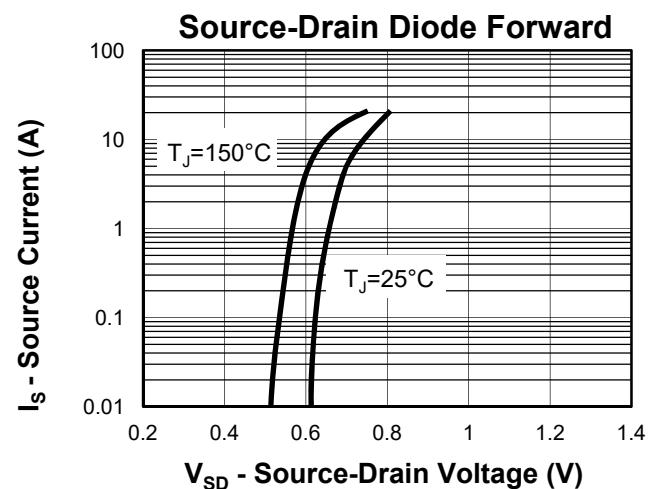
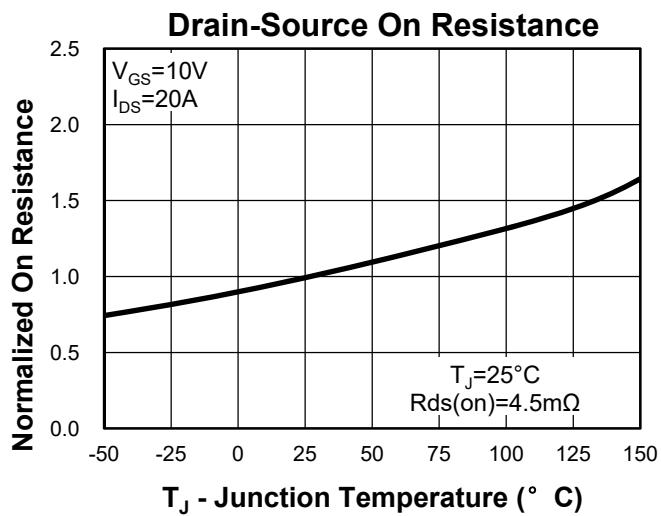
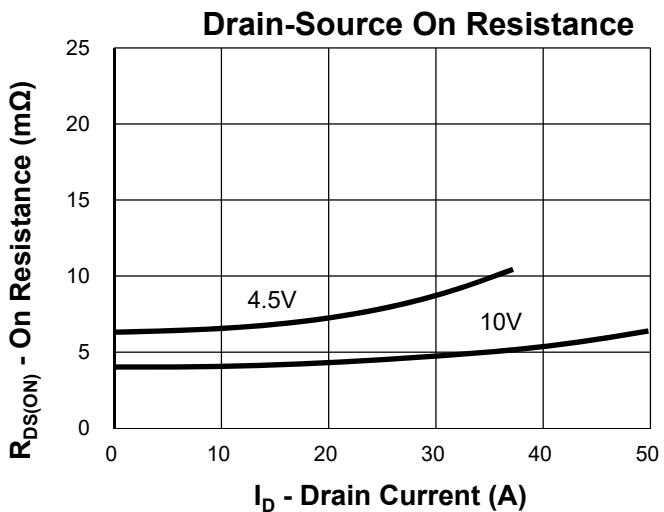
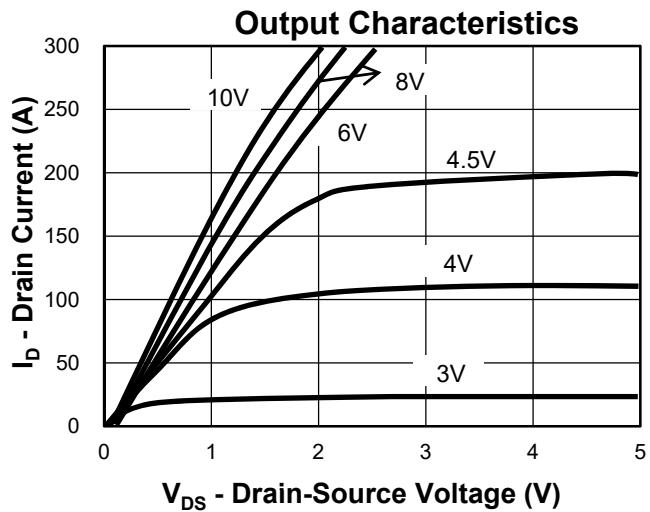
WW =Week.

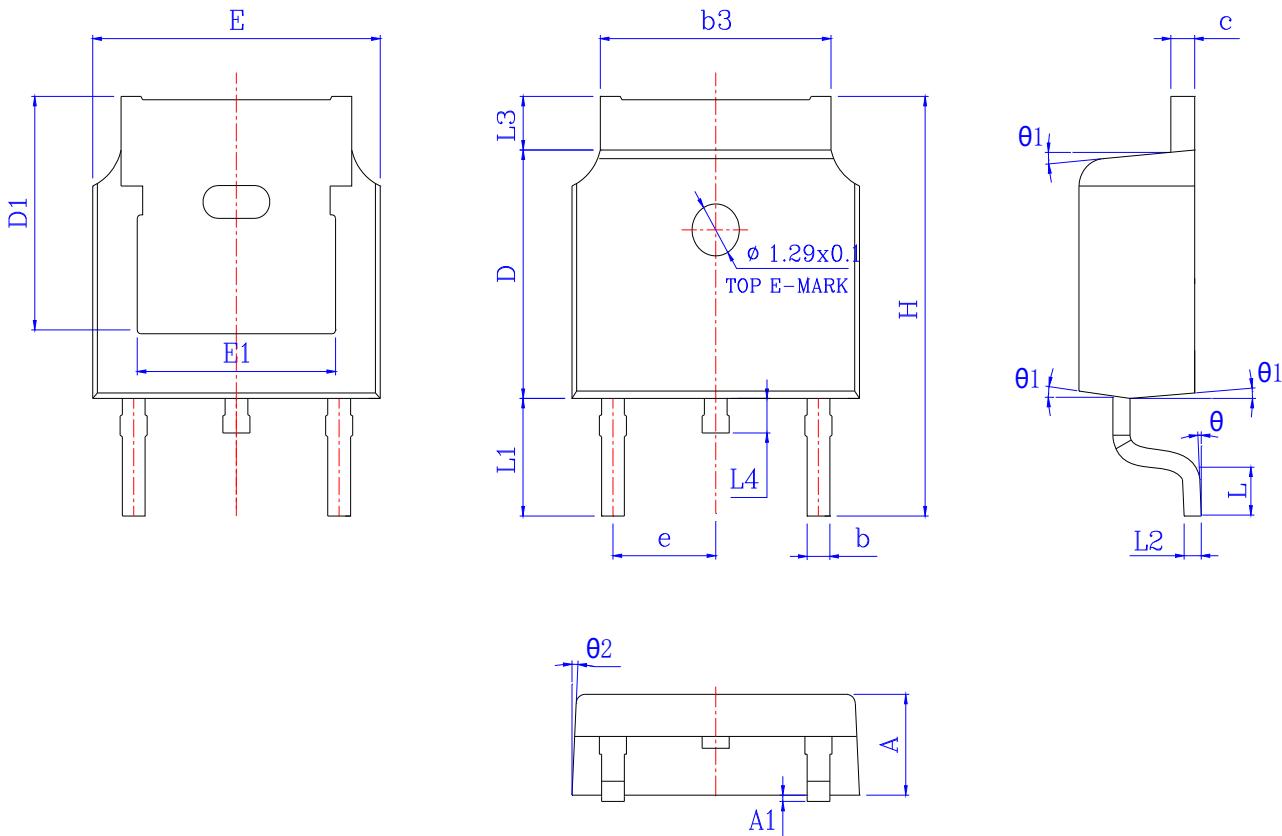
XXX =Lot number.

## Typical Characteristics



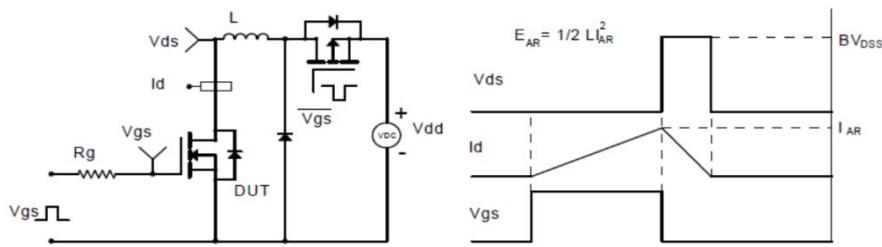
## Typical Characteristics



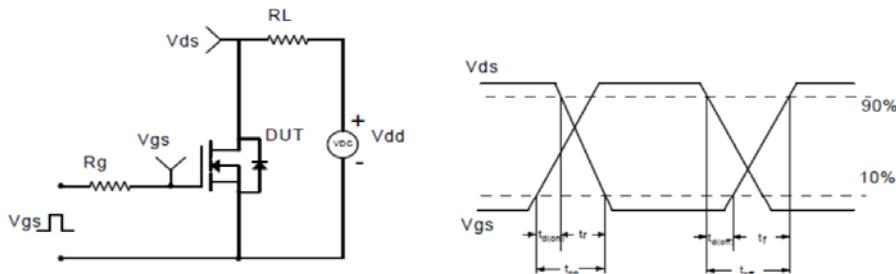
**Package Information**
**TO-252**


| SYMBOL | MM        |        |        | INCH      |       |       |
|--------|-----------|--------|--------|-----------|-------|-------|
|        | MIN       | NOM    | MAX    | MIN       | NOM   | MAX   |
| A      | 2.200     | 2.300  | 2.400  | 0.087     | 0.091 | 0.094 |
| A1     | *         | *      | 0.100  | *         | *     | 0.004 |
| b      | 0.660     | 0.760  | 0.860  | 0.026     | 0.030 | 0.034 |
| b3     | 5.130     | 5.295  | 5.460  | 0.202     | 0.208 | 0.215 |
| c      | 0.470     | 0.535  | 0.600  | 0.019     | 0.021 | 0.024 |
| D      | 6.000     | 6.100  | 6.200  | 0.236     | 0.240 | 0.244 |
| D1     | 5.30 REF  |        |        | 0.20 REF  |       |       |
| E      | 6.500     | 6.600  | 6.700  | 0.256     | 0.260 | 0.264 |
| E1     | 4.700     | 4.810  | 4.920  | 0.185     | 0.189 | 0.194 |
| e      | 2.28 REF  |        |        | 0.09 REF  |       |       |
| H      | 9.800     | 10.100 | 10.400 | 0.386     | 0.398 | 0.409 |
| L      | 1.400     | 1.550  | 1.700  | 0.055     | 0.061 | 0.067 |
| L1     | 2.743 REF |        |        | 0.108 REF |       |       |
| L2     | 0.510 BSC |        |        | 0.020 BSC |       |       |
| L3     | 0.900     | 1.075  | 1.250  | 0.035     | 0.042 | 0.049 |
| L4     | 0.600     | 0.800  | 1.000  | 0.024     | 0.031 | 0.039 |
| θ      | 0°        | *      | 8°     | 0°        | *     | 8°    |
| θ1     | 5°        | 7°     | 9°     | 5°        | 7°    | 9°    |
| θ2     | 5°        | 7°     | 9°     | 5°        | 7°    | 9°    |

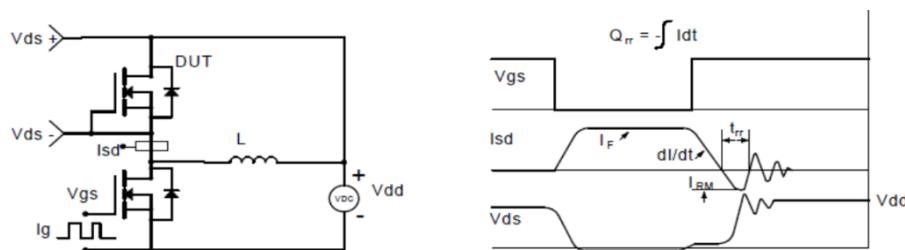
### Avalanche Test Circuit and Waveforms



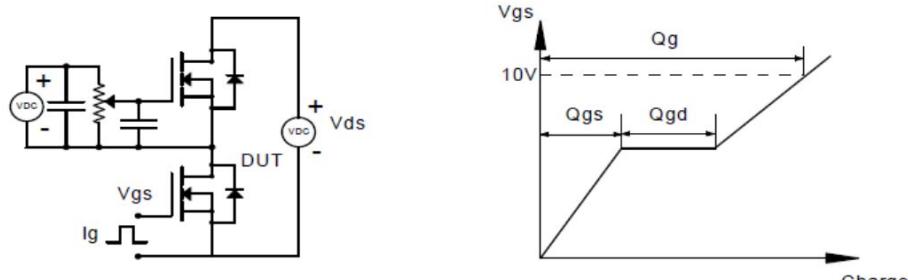
### Switching Time Test Circuit and Waveforms



### Diode Recovery Test Circuit and Waveforms



### Gate Charge Test Circuit and Waveform



### Customer Service

Kwansemi Semiconductor Co.,Ltd

Email:[Sales@kwansemi.com](mailto:Sales@kwansemi.com)

Web:[www.kwansemi.com](http://www.kwansemi.com)

### DISCLAIMER:

Kwansemi reserves the right to change the specifications and circuitry without notice at any time. The Products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any Product can reasonably be expected to result in a personal injury. Seller's customers using or selling Seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.